

Full Bridge Power Amplifier

FEATURES

- Precision Current Control
- $\pm 500\text{mA}$ Load Current
- 1.3V Typical Total V_{SAT} at 550mA
- Controlled Velocity Head Parking
- Precision Dual Supply Monitor with Indicator
- Range Control for 4:1 Gain Change
- Compensation Adjust Pin for Bandwidth Control
- Inhibit Input and UVLO
- 5V or 12V Operation
- 12mA Quiescent Supply Current
- PLCC, SOIC, and Low Profile Quad Flat Pack Packages

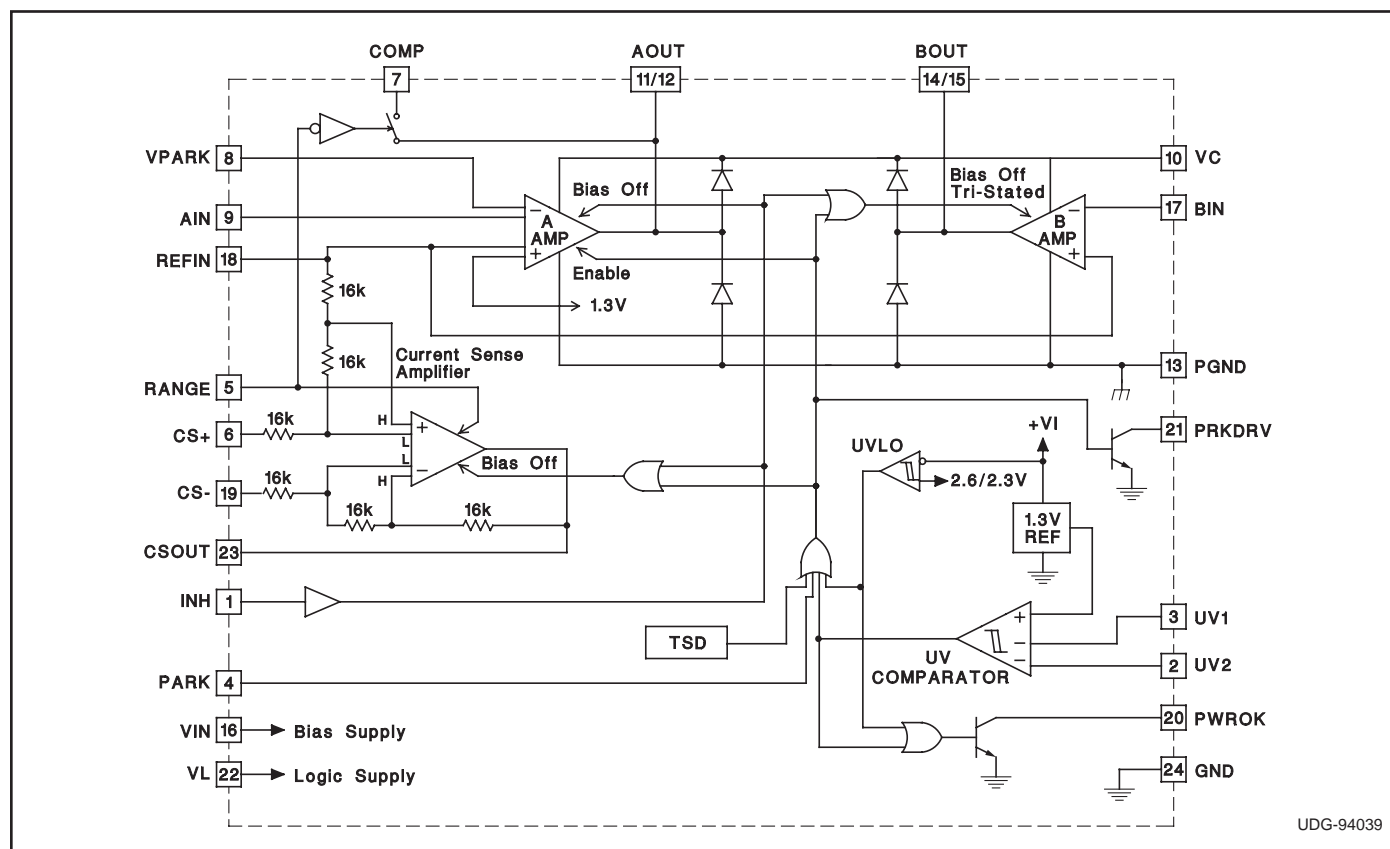
DESCRIPTION

This full bridge power amplifier, rated for continuous output current of 0.55A , is intended for use in demanding servo applications such as head positioning for high density disk drives. This device includes a precision current sense amplifier that senses load current with a single resistor in series with the load. The UC3173A is optimized to consume a minimum of supply current, and is designed to operate in both 5V and 12V systems. The power output stages have a low saturation voltage and are protected with current limiting and thermal shutdown. When inhibited the device will draw less than 1.5mA of total supply current.

Auxiliary functions on this device include a dual input undervoltage comparator, which can monitor two independent supply voltages and activate the built in head park function when either is below minimum. The park circuitry allows a programmable retract voltage to be applied to the load for limiting maximum head velocity. A separate low side parking drive pin permits a series impedance to be inserted to control maximum retract current. The parking drive function can be configured to operate with supply voltages as low as 1.2V .

The closed loop transconductance of the configured power amplifier can be switched between a high and low range with a logic input. The 4:1 change in gain can be used to extend the dynamic range of the servo loop. Bandwidth variations that would otherwise result with the gain change can be controlled with a compensation adjust pin.

BLOCK DIAGRAM



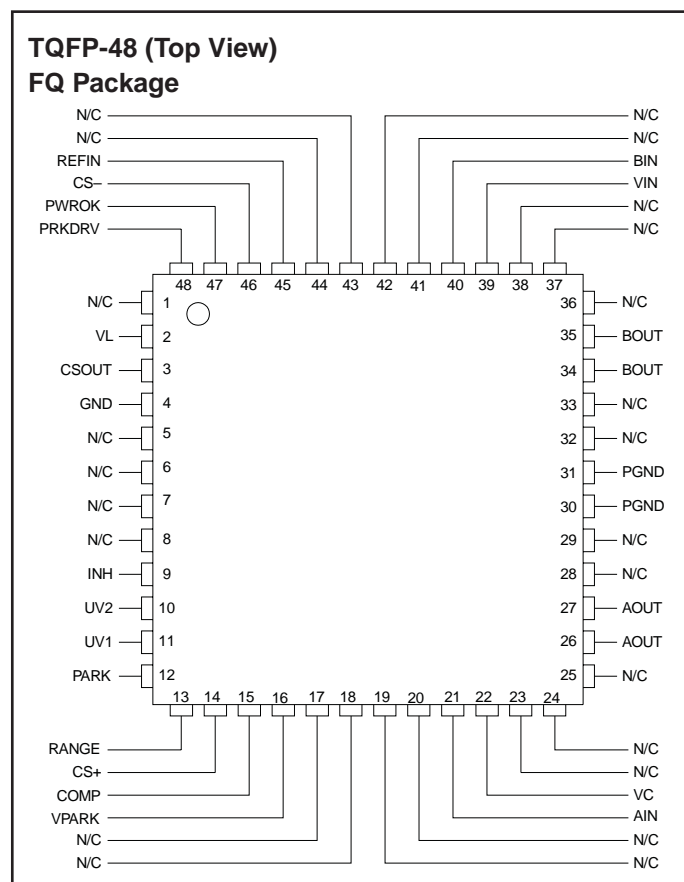
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ABSOLUTE MAXIMUM RATINGS (Note 1)

Input Supply Voltage, (VIN, VC, VL)	20V
UV Comparator	
Maximum Forced Voltage	-0.3V to 10V
Maximum Forced Current	± 10mA
B Amplifier Inverting Input	-0.3V to VIN + 1.0
A Amplifier Inverting Inputs, (Aux. and Normal)	-0.3V to VC + 1.0V
Open Collector Output Voltages	20V
A and B Output Currents (Continuous)	
Source	Internally Limited
Sink	0.6A
Parking Drive Output Current	
Continuous	150mA
Pulsed	1A
Output Diode Current (Pulsed)	0.6A
Power OK Output Current (Continuous)	30mA
Operating Junction Temperature	-55°C to +150°C
Storage Temperature	-65°C to +150°C
Lead Temperature	+300°C

Note 1: Unless otherwise indicated, voltages are referenced to ground and currents are positive into, negative out of, the specified terminals, "Pulsed" is defined as a less than 10% duty cycle pulse with a maximum duration of 500 μ s.

CONNECTION DIAGRAMS



THERMAL DATA

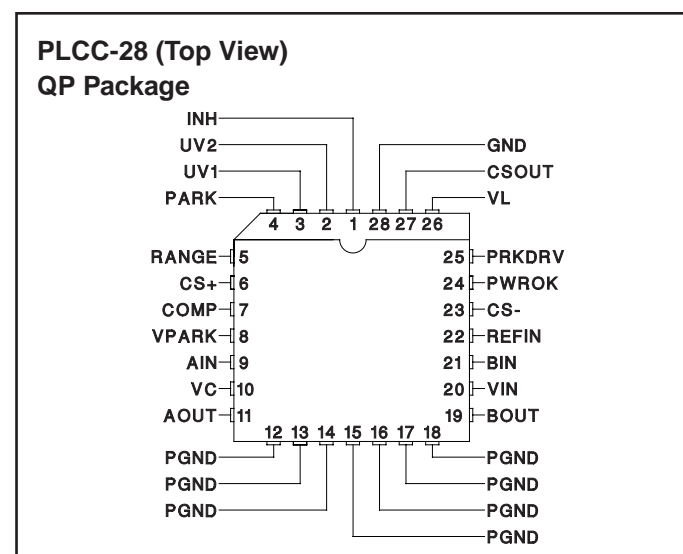
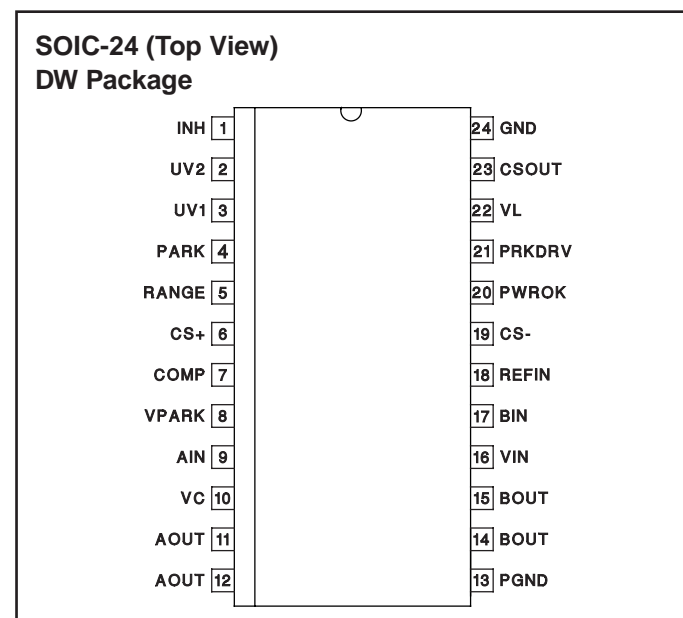
DW Package:
Thermal Resistance Junction to Leads, θ_{jl} 35°C/W
Thermal Resistance Junction to Ambient, θ_{ja} 60-70°C/W

FQ Package:
Thermal Resistance Junction to Leads, θ_{jl} 60°C/W
Thermal Resistance Junction to Ambient, θ_{ja} . . 110-120°C/W

QP Package:
Thermal Resistance Junction to Leads, θ_{jl} 15°C/W
Thermal Resistance Junction to Ambient, θ_{ja} 30-40°C/W

Note 2: The above numbers for θ_{jl} are maximums for the limiting thermal resistance of the package in a standard mounting configuration. The θ_{ja} numbers are meant to be guide lines for the thermal performance of the device/pc-board system. All of the above numbers assume no ambient airflow.

Note 3: Consult Packaging Section of Unitrode Integrated Circuits databook for thermal specifications and limitations of packages.



ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for $T_A = 0$ to $+70^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_C = V_{IN} = V_L$, $REF_{IN} = V_{IN}/2$, $RANGE$, $PARK$, and $INH = 0\text{V}$, and $T_A = T_J$.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Input Supply					
VIN Supply Current			10	13	mA
VC Supply Current	$I_{OUT} = 0\text{A}$		1.2	2.0	mA
VL Supply Current			0.65	1.0	mA
Total Supply Current	Supplies = 5V, $I_{OUT} = 0\text{A}$		12	16	mA
	Supplies = 12V, $I_{OUT} = 0\text{A}$		13	18	mA
VL UVLO Threshold	Low to High		2.6	2.8	V
UVLO Threshold Hysteresis			300		mV
Under Voltage (UV) Comparator					
Input Bias Current	Max at Either UV Input		-0.25	-1.0	μA
UV Thresholds	Low to High, Other Input = 5V	1.28	1.3	1.32	V
UV Threshold Hysteresis		19	24	29	mV
PWROK Vsat	$I_{OUT} = 5\text{mA}$, UV Input Low		0.15	0.45	V
PWROK Leakage	$V_{OUT} = 20\text{V}$			5	μA
Power Amplifiers A and B					
Input Offset Voltage	A Amplifier, $V_{CM} = 2.5\text{V}$			4	mV
	B Amplifier, $V_{CM} = 2.5\text{V}$			12	mV
Input Bias Current	$V_{CM} = 2.5\text{V}$, Inverting Inputs Only		-150	-500	nA
Input Bias Current at Ref. Input	$(REF_{IN} - CS+)/48\text{k}\Omega$, $T_J = 25^\circ\text{C}$	15	21	27	$\mu\text{A}/\text{V}$
CMRR	$V_{CM} = 1\text{V}$ to 10V , Supplies = 12V	70	90		dB
PSRR	$V_{IN} = 4\text{V}$ to 15V , $V_{CM} = 1.5\text{V}$	70	90		dB
Large Signal Voltage Gain	Supplies = 12V, $V_{OUT} = 1\text{V}$, $I_{OUT} = 300\text{mA}$ to $V_{OUT} = 11\text{V}$, $I_{OUT} = -300\text{mA}$	3.0	15.0		V/mV
Gain Bandwidth Product	A Amplifier (Note 4)		2.0		MHz
	B Amplifier (Note 4)		1.0		MHz
Slew Rate	(Note 4)		1.0		V/ μs
High-Side Current Limit	Low Range Mode	0.6	0.8		A
	High Range Mode	1.1	1.6		A
Output Saturation Voltage	High-Side, $I_{OUT} = -100\text{mA}$ (Note 5)		0.7		V
	High-Side, $I_{OUT} = -300\text{mA}$ (Note 5)		0.8		V
	High-Side, $I_{OUT} = -550\text{mA}$ (Note 5)		0.95		V
	Low-Side, $I_{OUT} = 100\text{mA}$		0.2		V
	Low-Side, $I_{OUT} = 300\text{mA}$		0.25		V
	Low-Side, $I_{OUT} = 550\text{mA}$		0.35		V
	Total V_{SAT} , $I_{OUT} = 100\text{mA}$		0.9	1.2	V
	Total V_{SAT} , $I_{OUT} = 300\text{mA}$		1.05	1.4	V
	Total V_{SAT} , $I_{OUT} = 550\text{mA}$		1.3	1.7	V
VC to VIN Headroom	Volts below V_{IN} , delta High-Side, $V_{SAT} = 100\text{mV}$, $I_{OUT} = -550\text{mA}$ (Note 5)	0.23	0.4		V
High-Side Diode, V_F	$I_D = 550\text{mA}$		1.0		V
Low-Side Diode, V_F	$I_D = 550\text{mA}$, INH Activated, B Amplifier Only		1.0		V

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for $T_A = 0$ to $+70^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_C = V_{IN} = V_L$, $REF_{IN} = V_{IN}/2$, $RANGE$, $PARK$, and $INH = 0\text{V}$, and $T_A = T_J$.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Current Sense Amplifier					
Input Offset Voltage	$V_{CM} = 2.5\text{V}$, Low range mode			2.0	mV
	$V_{CM} = 2.5\text{V}$, High range mode			4.0	mV
Input Offset Change with Common Mode Input	$V_{CM} = -1\text{V}$ to 13V , Supplies = 12V , Low Range Mode			2000	$\mu\text{V/V}$
	$V_{CM} = -1\text{V}$ to 13V , Supplies = 12V , High Range Mode			4000	$\mu\text{V/V}$
Voltage Gain	$V_{DIFF} = +1.0$ to -1.0V , $V_{CM} = 2.5\text{V}$, High Range Mode	0.485	0.50	0.515	V/V
	$V_{DIFF} = +1.0$ to -1.0V , $V_{CM} = 2.5\text{V}$, Low Range Mode	1.95	2.0	2.05	V/V
Saturation Voltage	Low-Side, $I_{OUT} = 1\text{mA}$		0.1	0.3	V
	High-Side, $I_{OUT} = -1\text{mA}$, Referenced to V_{IN}		0.1	0.3	V
Parking Function					
Park Input Threshold Voltage		0.6	1.1	1.7	V
Park Input Threshold Current	Internal Pull-Up, $V_{IN} = 0.6\text{V}$		50	75	μA
Park Drive Saturation Voltage	$I_{OUT} = 50\text{mA}$		0.15	0.35	V
Park Drive Leakage	$V_{OUT} = 20\text{V}$			50	μA
Regulating Voltage at Park Volts Input		1.275	1.30	1.325	V
Amplifier A Auxiliary Input Bias Current			-300	-750	nA
Amplifier A Parking High-Side Saturation Voltage	$I_{OUT} = -50\text{mA}$, $V_{IN} = 0\text{V}$, $V_C = V_L = 5\text{V}$, $PARK$ Open, V_C to V_{OUT}		0.8	0.95	V
Minimum Parking Supply	At V_C and V_L , $V_{IN} = 0\text{V}$, A Amplifier Out - $V_{SAT} PRKDRV > 0.5\text{V}$, $I_{PARK} = 50\text{mA}$		1.4	1.7	V
Minimum Supply for Parking Drive and Power OK Operation	At V_L , $V_C = V_{IN} = 0\text{V}$, $V_{SAT} < 0.5\text{V}$, $I_{OUT} PRKDRV = 50\text{mA}$, $R_I = 30\Omega$ to 2V		1.1	1.4	V
	$I_{OUT} PWROK = 5\text{mA}$, $R_I = 300\Omega$ to 2V		1.2	1.6	V
V_L Parking Supply Current	$PARK$ Open, $V_L = 5\text{V}$, $V_C = 1.6\text{V}$, $V_{IN} = 0\text{V}$, $PWROK I_{OUT} = 5\text{mA}$, $PRKDRV I_{OUT} = 50\text{mA}$		1.6	3.0	mA
Auxiliary Functions					
Inhibit Input Threshold		0.6	1.1	1.7	V
Inhibit Input Current	$INH = 1.7\text{V}$		-0.5	-1.0	μA
Range Input Threshold		0.6	1.1	1.7	V
Range Input Current	$RANGE = 1.7\text{V}$		50	100	μA
Comp Adjust Pin Saturation Voltage	$RANGE = 0\text{V}$, Pin Current = $\pm 500\mu\text{A}$, Referenced to A_{OUT}		0.02	0.1	V
Comp Adjust Leakage Current	$RANGE = 1.7\text{V}$, Supplies = 12V , $A_{OUT} - V_{COMP} = \pm 6\text{V}$			5	μA
Total Supply Current when Inhibited	V_{IN} , V_C , and V_L currents		1.0	1.5	mA
Thermal Shutdown Temperature	(Note 4)		165		$^\circ\text{C}$

Note 4: Guaranteed by design. Not 100% tested in production.

Note 5: The high-side saturation performance of the UC3173A is referenced to the V_{IN} supply pin.

The V_C supply pin can operate about 400mV below the V_{IN} supply input without affecting the performance.

PIN DESCRIPTIONS

AIN: Inverting input to the A amplifier. Used as the summing node to close the loop on the overall power amplifier.

AOUT: Output for the A power amplifier, providing one end of the differential drive to the load during normal operation and during park. During a UVLO condition at the VIN supply pin, this output is forced to a high, source only state. When the UC3173A is inhibited, this output will be set high, in a source only state.

BIN: Inverting input to the B amplifier. Used to program the gain of the B amplifier to guarantee maximum voltage swing to the load.

BOUT: Output for the B power amplifier, providing one end of the differential drive to the load during normal operation. During park and while inhibited this pin is tristated.

COMP: The compensation adjust pin allows the user to provide an auxiliary compensation network for the A amplifier that is only active when the current sense amplifier is in the low range. With this option, the user can control the change in bandwidth that would otherwise result from the gain change in the feedback loop.

CS–: The inverting input to the current sense amplifier is typically tied to the load side of the series current sense resistor. This pin can be pulled below ground during an abrupt load current change with an inductive load. Proper operation of the current sense amplifier will result if this pin does not go below ground by an amount greater than: $\text{REFIN} / 2 - 0.3\text{V}$, in low range mode, and $2 \bullet \text{REFIN} - 0.9\text{V}$, in high range mode.

CS+: The noninverting input to the current sense amplifier is typically tied to the connection between the A amplifier output and the current sense resistor connected in series with the load.

CSOUT: The output of the current sense amplifier has a 1.5mA current source pull-up and an active NPN pull-down. The output will pull to within 0.3V of either rail with a load current of less than 1mA.

GND: Reference point for the internal reference, UV comparator, and other low level circuitry.

INH: A high impedance logic input that disables the A and B power amplifiers, as well as the Current Sense amplifier. The UV comparators and logic functions of the UC3173A remain active. This input has an internal pull-up that will inhibit the device if the input is left open. The Inhibit function is overridden by any condition that forces the Park function to be activated.

PARK: Input that forces the park condition on the UC3173A. This input has an internal pull-up that will force the park condition if the pin is left open.

PGND: Current return for all high level circuitry, this pin should be connected to the same potential as GND.

PRKDRV: A 100mA drive output that is active low during a park operation. This pin is normally used to supply the lowside drive to the load during parking, in place of the B amplifier. A series resistor can be added between this pin and the load to limit current during park.

PWROK: Indicates with an active low condition that either of the UV inputs are low, or that the supply voltage at the VL input to the UC3173A has dropped below the UVLO threshold. This output will remain active low until the VL supply has dropped to below approximately 1.2V.

RANGE: When this pin is open or at a logic low potential, the current sense amplifier will be in its low range mode. In this mode the voltage gain of the amplifier will be 2. If this pin is brought to a logic high, the gain of the current sense amplifier will change into its high range value of 0.5. This factor of four change in gain will vary the overall transconductance of the power amplifier by the same ratio, with the transconductance being the highest in the high mode. This feature allows improved dynamic range of load current control for a given control input range and resolution.

REFIN: Reference for input control signals to the power amplifier, as well as, the noninverting inputs to the A and B amplifiers, and the output level shift for the CS amplifier.

VC: High current supply to the collectors of the high side NPN output devices on the A and B amplifiers. This supply should be powered whenever the A or B amplifiers are activated. This pin can operate approximately 400mV below the VIN supply without affecting the voltage available to the load. This supply pin provides drive to the power amplifiers during a parking operation.

VIN: Provides bias supply to both the power amplifiers and the current sense amplifiers. The high-side drive to the power stages on both the A and B amplifiers is referenced to this pin. The high side saturation voltages are specified and measured with respect to this supply pin. The parking function of the device is fully operational independent of the voltage at this pin.

PIN DESCRIPTIONS (cont.)

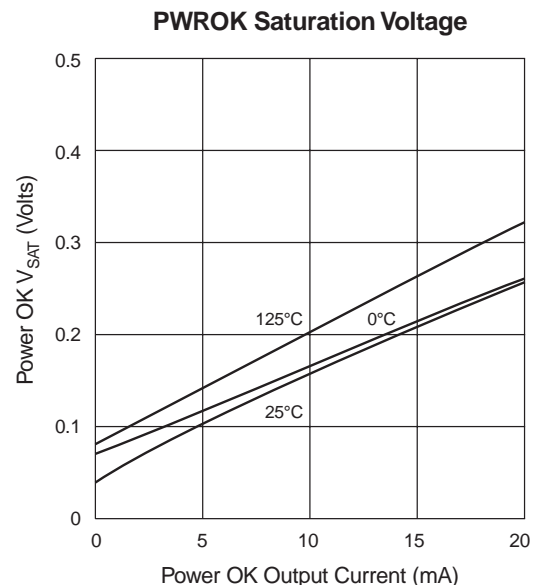
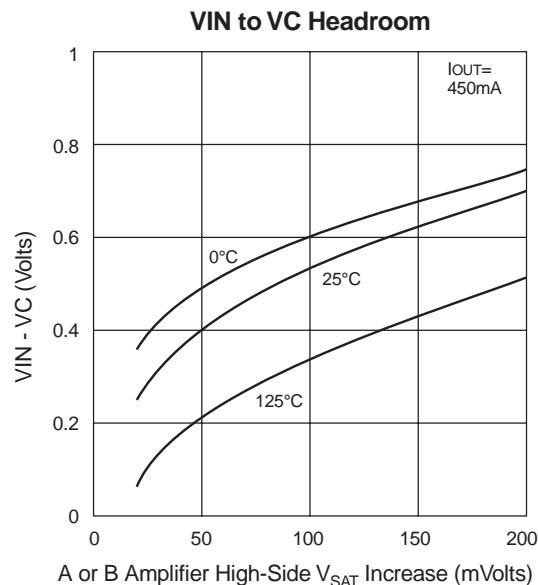
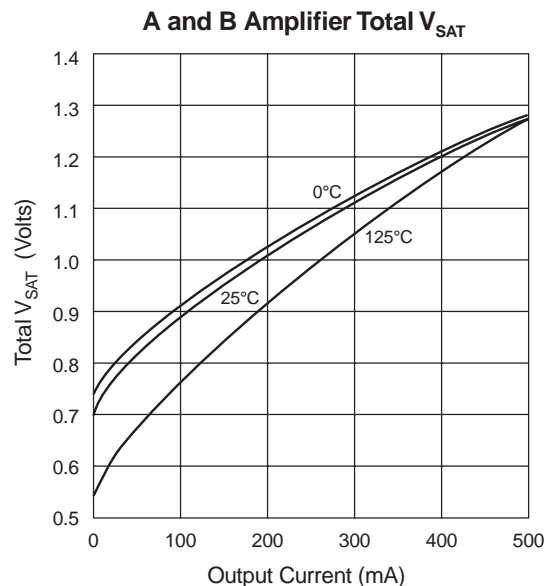
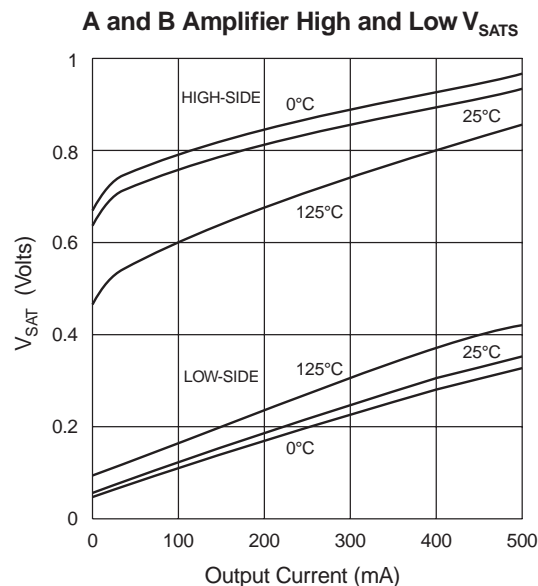
VL: Logic portions of the UC3173A are powered by this supply pin, including the reference, UVLO, the UV comparators, and the PRKDRV and PWROK outputs. This pin is a low current supply that would normally be tied to the VC pin, or to a parking hold up capacitor for extended parking operation with very low recovered back emf.

VPARK: The auxiliary inverting input to the A amplifier, activated during park conditions on the UC3173A. An internal auxiliary non-inverting input is connected to the 1.3V reference. When the auxiliary inputs are activated, the A amplifier will force a programmed voltage at its output for a maximum back-emf/velocity retract of the head. The park condition on the UC3173A is always activated

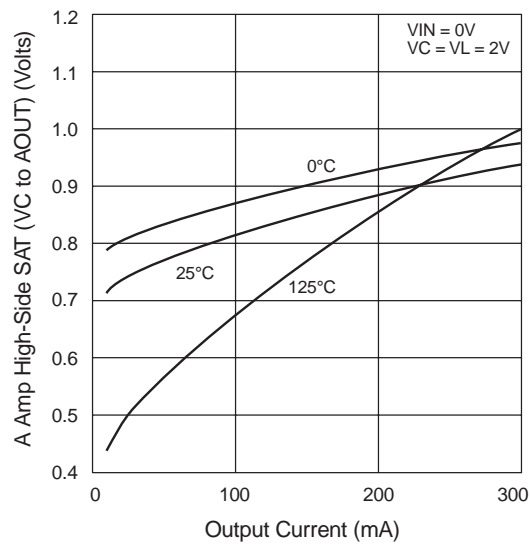
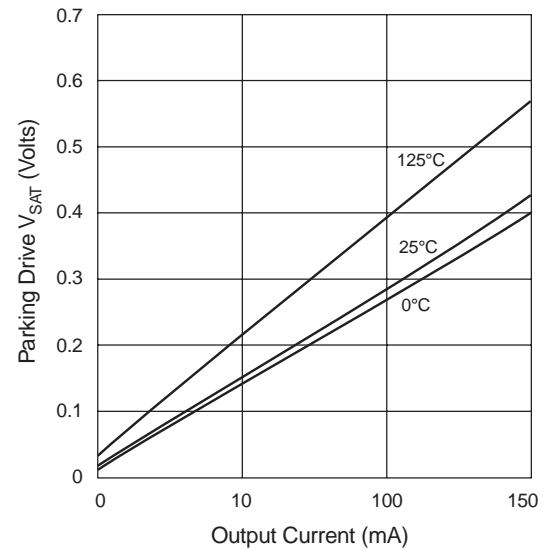
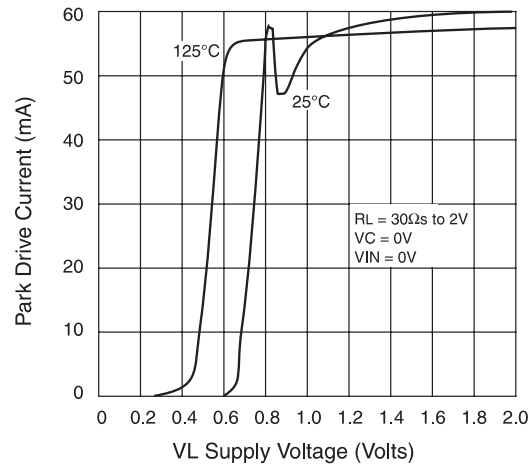
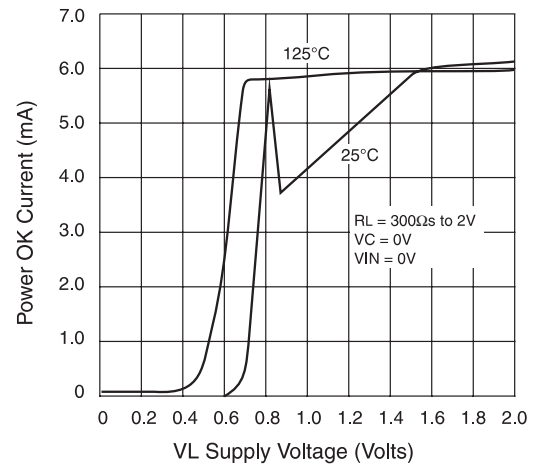
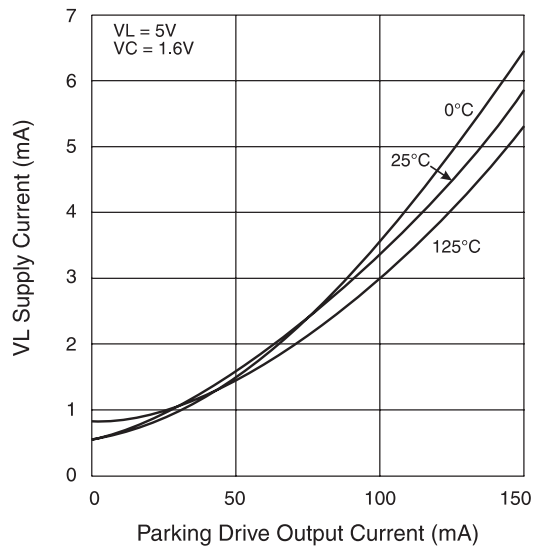
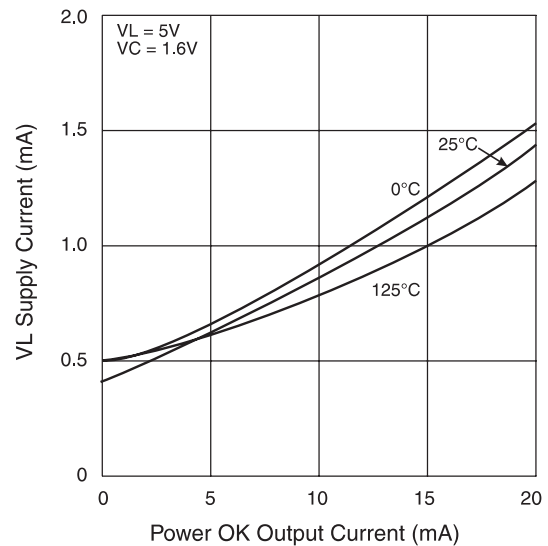
by any one of the following four conditions, 1: a low condition on either of the UV inputs, 2: a high input level at the Park input, 3: a UVLO condition at the VL supply pin, and 4: activation of the TSD, (thermal shutdown) protection circuit. During a UVLO condition at the VL pin the auxiliary inputs to the A amplifier are over-ridden, and the A amplifier output is forced to its high state.

UV1 & 2: Inputs to the UV comparator, these inputs are high impedance sensing points used to monitor external supply conditions. Either of the inputs going low will force the device into a park condition, and force the PWROK output to an active low state. If either of these inputs is not used it should be connected to a voltage greater than 1.3V.

APPLICATION INFORMATION



APPLICATION INFORMATION (cont.)

A Amplifier High-Side V_{SAT} in Park Mode**PRKDRV Saturation Voltage****PRKDRV Current vs. VL Supply****PWROK vs. VL Supply****VL Current vs. PRKDRV Current****VL Current vs. PWROK Current**

APPLICATION INFORMATION (cont.)

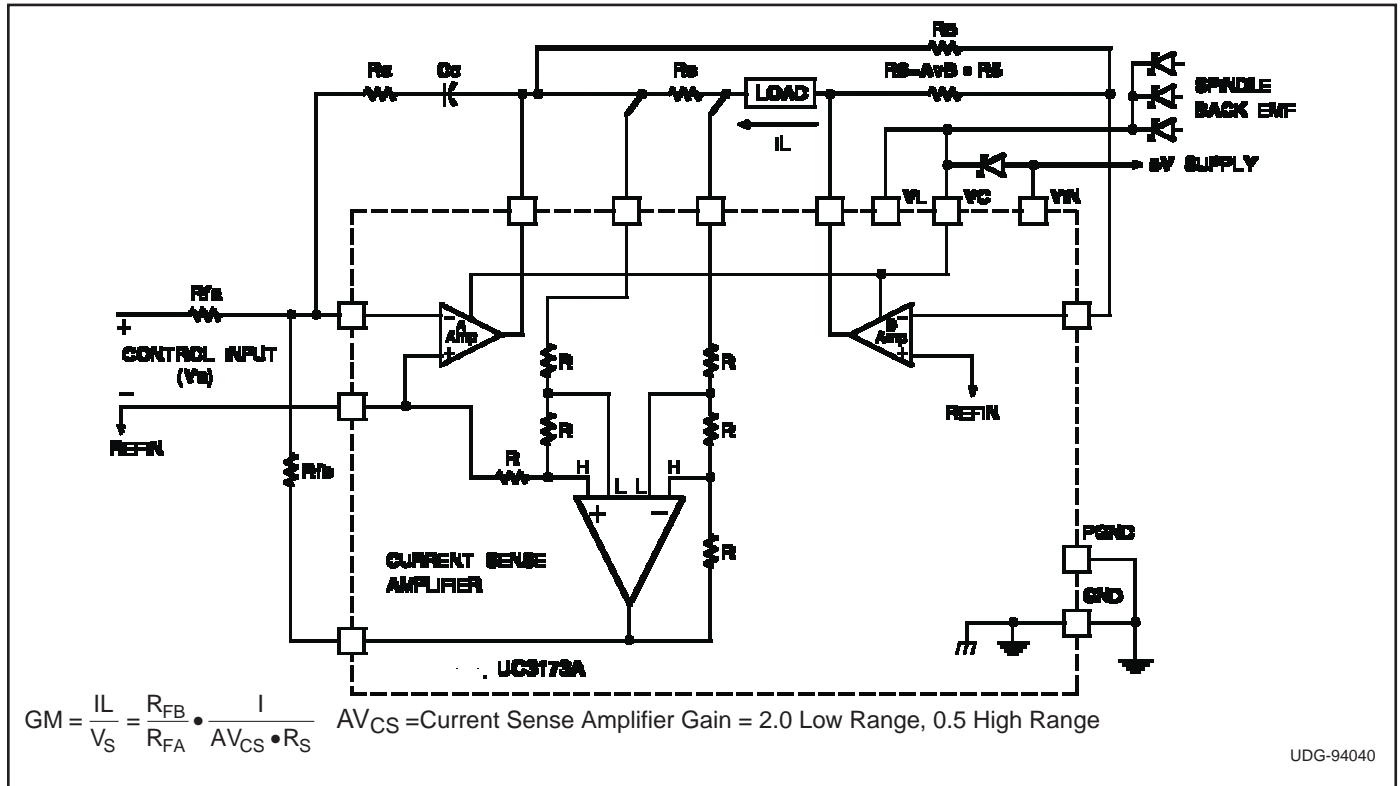


Figure 1. Typical application.

Design Procedure for Application of the UC3173A

The following is a simple design flow that can be used to configure the UC3173A Full Bridge Power Amplifiers as shown in Fig. 1.

Definitions:

- f_{3DB} = the closed loop 3dB bandwidth
- A_{VB} = B amplifier closed loop gain, = R_6/R_5
- A_{VCS} = current sense amplifier gain, = 0.5 in high range, and 2.0 in low range
- f_{GBWA} = gain bandwidth product of the A amplifier
- G_{mHR} = closed loop transconductance in high rangemode
- G_{mLR} = closed loop transconductance in low range mode
- L = load inductance
- R_L = load resistance

A. Current Sense Resistor

Choose R_S to be as large as head room will tolerate, this is the series current sense resistor.

B. Select Feedback Resistance

Choose a value of R_{FB} to be less than the peak current sense amplifier swing divided by 1mA. A value in the range of 3k to 10k is suggested.

C. Set Transconductance

Calculate R_{FA} according to:

$$R_{FA} = \frac{R_{FB}}{0.5 \cdot R_S \cdot G_{mHR}} \quad (1)$$

If the range change option is not going to be used, it is recommended that the device be set in the low range mode and R_{FA} be calculated by:

$$R_{FA} = \frac{R_{FB}}{2 \cdot R_S \cdot G_{mLR}} \quad (2)$$

D. Optimize Voltage Swing

In order to assure that maximum voltage drive to the load is achievable, there are some precautions that should be taken. In a standard configuration, the B amplifier is slaved to the A amplifier. The bias point of the and the gain of the B amplifier, as well as the saturation voltages of the power output stages, will affect the voltage available to the load.

There are two simple procedures to follow, either will insure that the capabilities of the device are fully utilized. The first is to set the REF pin voltage at the center of the available voltage swing at the output of the power amplifiers. This optimum reference is defined by equation (3)

APPLICATION INFORMATION (cont.)

$$V_{REFIN} \text{ (optimum)} = \frac{V_{IN} - V_{HS(SAT)} + V_{LS(SAT)}}{2} \quad (3)$$

Where: $V_{HS(SAT)}$ = high-side V_{SAT} at maximum load
 $V_{LS(SAT)}$ = low-side V_{SAT} at maximum load.

A second approach is to raise the gain of the B amplifier to insure maximum swing. For a given V_{REFIN} voltage the gain of the B amplifier, set by the ratio of the feedback resistors, can be made greater than unity as given by:

$$A_{VB} = \frac{V_{IN} - V_{HS(SAT)} - V_{REF}}{V_{REFIN} - V_{LS(SAT)}} \text{ or,} \quad (4)$$

$$\frac{V_{REFIN} - V_{LS(SAT)}}{V_{IN} - V_{HS(SAT)} - V_{REF}}$$

whichever is greater than unity.

For a typical case, where V_{REFIN} has been set at $V_{IN}/2$, the required gain for a 5 volt system will be about 1.5, and for a 12 volt system, 1.2.

It is worth noting that when using this method the B amplifier will saturate before the A amplifier on one polarity of the voltage swing. During the time when the B amplifier is saturated and the A amplifier is not, the small signal bandwidth of the loop will be reduced by a factor of $(A_{VB} + 1)$.

E. Loop Compensation

The normal configuration for compensation of the power amplifier is shown in Fig. 1. A simple R_C network, $R_C C_C$, around the A amplifier is all that is required. The value of the $R_C C_C$ time constant is typically chosen to correspond to the electrical time constant of the load, given by R_L/L .

The bandwidth of the closed loop amplifier can be set by choosing the value of R_C . Calculate R_C according to:

$$R_C = \frac{2\pi L \cdot f_{3dB} \cdot R_{FB}}{(1 + A_{VB})A_{VCS} \cdot R_S} \quad (5)$$

Use $A_{VCS} = 0.5$ if range changing is to be used, and $A_{VCS} = 2.0$ if only the low range mode of operation is to be used.

The compensation zero is typically set to coincide with the L/R time constant of the Load. C_C can then be calculated by:

$$C_C = \frac{L}{R_C(R_S + R_L)} \quad (6)$$

In the closed loop transconductance amplifier, the A am-

plifier operates at the highest noise gain. Noise gain is a measure of the feedback ratio at which the amplifier is operating. For the configuration of the A amplifier in Fig. 1, the noise gain is given by the impedance ratio of the R_C - C_C series network, to the parallel combination of R_{FA} and R_{FB} . For the A amplifier to operate at its expected closed loop gain, the noise gain at any frequency must not exceed its Gain Bandwidth Product (GBW) divided by that frequency. Applying this to the expression above will yield a result for the maximum 3dB bandwidth that can be achieved for a given configuration.

$$f_{3dB(MAX)} = \left(\frac{f_{GBW} A \cdot (1 + A_{VB}) \cdot A_{VCS} \cdot R_S \cdot R_{FA}}{2\pi L \cdot (R_{FA} + R_{FB})} \right) \frac{1}{2} \quad (7)$$

Where: $f_{GBW}A$ is the GBW of the A amplifier.

In the UC3173A, to accommodate wider power amplifier bandwidths, the GBW Product of the A amplifier has been extended to 2MHz. Care should be taken that the A amplifier gain bandwidth product is not limiting the closed loop performance of the configured power amplifier. This is easily checked by making sure that R_C is less than a critical value, $R_{C(MAX)}$, as given by:

$$R_{C(MAX)} = R_{FB} \left(\frac{f_{GBW} A \cdot 2\pi L \cdot R_{FA}}{(A_{VB} + 1) \cdot A_{VCS} \cdot R_S (R_{FA} + R_{FB})} \right) \frac{1}{2} \quad (8)$$

Again, use $A_{VCS} = 0.5$ if range changing is used, and $A_{VCS} = 2.0$ if only the low range mode of operation is used.

F. Using The Comp Pin

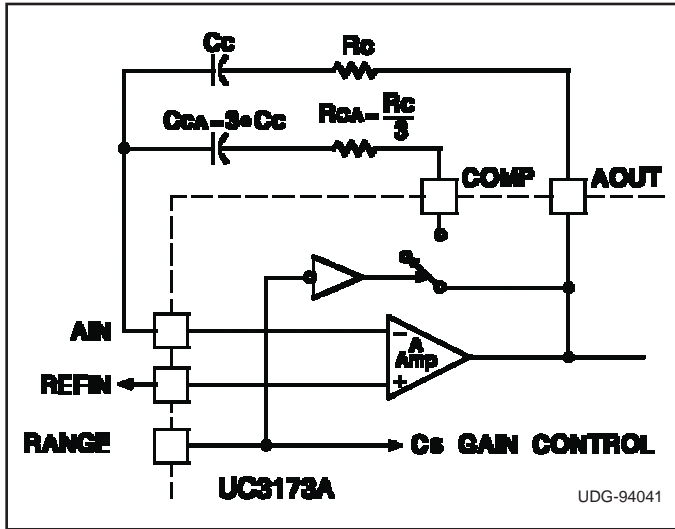
When the range change feature of the UC3173A is used, the closed loop bandwidth of the power amplifier will change according to (7). In other words, the bandwidth would be four times larger during the low range mode when A_{VCS} is equal to 2, than during the high range mode when A_{VCS} is equal to 0.5, unless the value of R_C is adjusted to compensate.

The COMP pin on the UC3173A can be used to do this. The COMP pin acts as a simple switch that allows a parallel compensation network to be applied around the A amplifier during low range operation. A simple network as shown here will keep the loop response constant independent of the range condition.

To maintain the same 3dB bandwidth in both the high and low range modes set R_{CA} and C_{CA} to:

$$R_{CA} = \frac{R_C}{3}, \quad C_{CA} = 3C_C \quad (9)$$

APPLICATION INFORMATION (cont.)



The COMP pin switches in a parallel compensation network to stabilize the small signal bandwidth with range changes.

Head Parking

In Fig. 2, the UC3173A is shown configured to force a programmed voltage at the A amplifier output upon the activation of a park condition. A pair of feedback resistors R1 and R2 set this voltage as defined by:

$$R1 = R2 \left(\frac{VPARK}{1.3} - 1 \right) \quad (10)$$

R2 is typically chosen in the range of 10kΩ to 100kΩ.

The B amplifier output is tri-stated during park, this side of the load is driven low by the PRKDRV pin. A series resistor, RP in the figure, can be inserted in series with the load to limit the peak current if required.

The UV thresholds for the supply monitors are set by picking R4 and R6 values in the 10kΩ to 100kΩ range and then calculating R3 and R5 according to:

$$R3 = R4 \left(\frac{UV1}{1.3} - 1 \right), \text{ and } R5 = R6 \left(\frac{UV2}{1.3} - 1 \right) \quad (11)$$

During park, supply to the load, and the UC3173A, is typically recovered from the back EMF of the spindle motor. When the supply voltage at the VL supply pin drops below the UVLO voltage, (2.3V high-to-low), the output of the A amplifier is forced high, over-riding the programmed park voltage. The UC3173A will maintain drive to the load down to low supply levels. For example, with 1.5 volts of recovered back EMF, the UC3173A can still deliver 50mA of drive to a 10Ω load.

Parking With Very Low Back EMF

The UC3173A can also be configured to get parking drive to the load with very low recovered back EMF. Fig. 3 illustrates how the PWROK pin can be used to drive an external PNP device to achieve very low parking drive V_{SAT} losses. With this configuration, the UC3173A will be able to force approximately one volt across the load with a recovered back EMF voltage of 1.3V.

During system commanded parking with the supplies present, the VPARK pin is still used to set the maximum voltage to the load. The logic function of the PWROK pin is still available since the external PNP will provide isolation to this output when it is high.

Base drive to the PRKDRV and PWROK pins are provided by the VL supply pin. By using a hold up capacitor, C_{HOLD} , the drive can be maintained to the load as the back EMF drops to below 1V. A variation on this approach is to add a connection between the VL pin and the recovered back EMF, this will eliminate the need for the holdup capacitor and provide operation down to about 1.2V of back EMF recovery. Care with this approach should be taken in case the 5V supply hangs at just below the programmed UV threshold. In this situation large currents could flow from this supply through the external PNP and into the A output which, until the supply drops below a certain level, is forcing a programmed voltage.

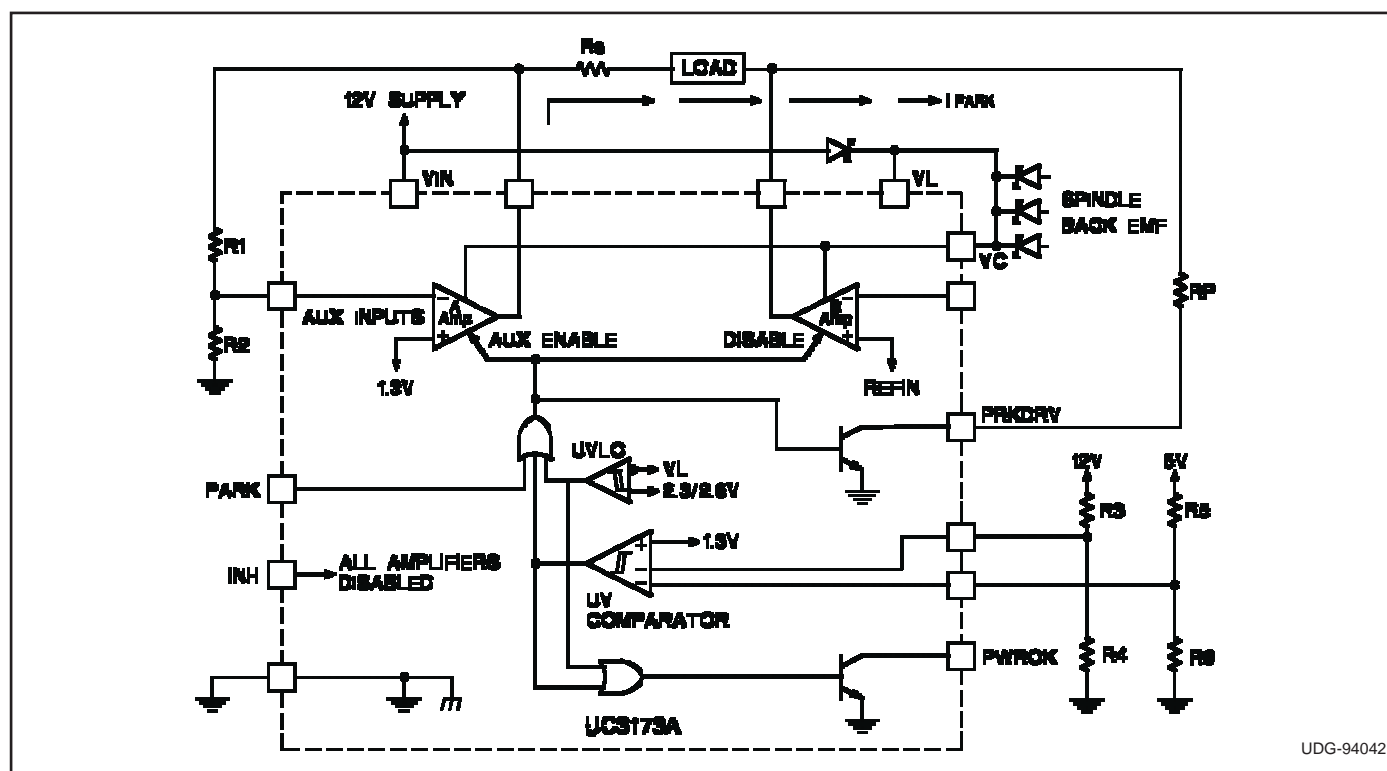


Figure 2. Controlled velocity head parking.

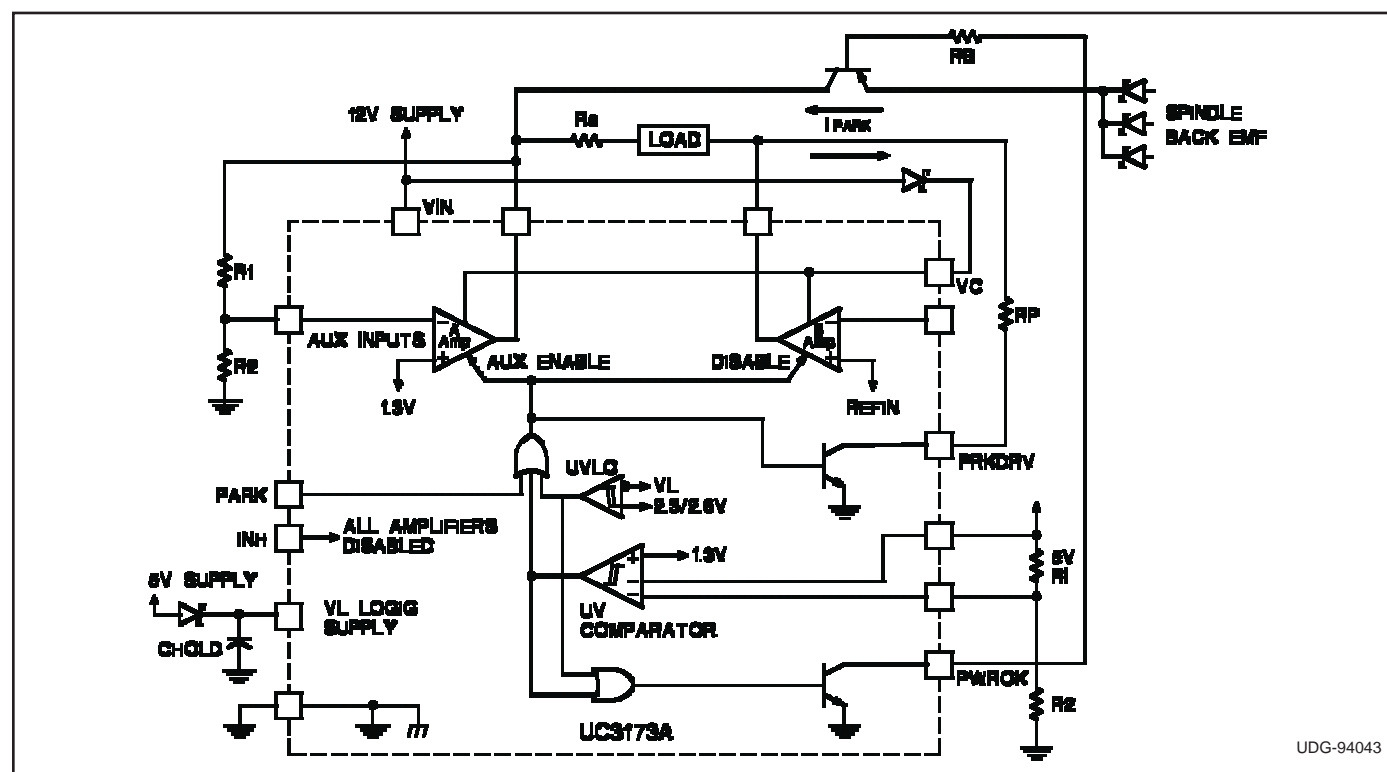


Figure 3. Head parking with low back EMF.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
UC3173AQP	OBSOLETE	PLCC	FN	28		TBD	Call TI	Call TI
UC3173AQPTR	OBSOLETE	PLCC	FN	28		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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